

## APT10035JLL

**1000V 25A 0.350** Ω

# POWER MOS 7™

Power MOS  $7^{\text{TM}}$  is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS  $7^{\text{TM}}$  by significantly lowering  $R_{\text{DS(ON)}}$  and  $Q_g$ . Power MOS  $7^{\text{TM}}$  combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.



Increased Power Dissipation

• Lower Miller Capacitance

Easier To Drive

• Lower Gate Charge, Qg

Popular SOT-227 Package





#### **MAXIMUM RATINGS**

All Ratings:  $T_C = 25^{\circ}C$  unless otherwise specified.

| Symbol            | Parameter   | APT10035JLL | UNIT   |  |
|-------------------|---|-------------|--------|--|
| V <sub>DSS</sub>  | Drain-Source Voltage                              | 1000        | Volts  |  |
| I <sub>D</sub>    | Continuous Drain Current @ T <sub>C</sub> = 25°C  | 25          | A      |  |
| I <sub>DM</sub>   | Pulsed Drain Current <sup>①</sup>                 | 100         | Amps   |  |
| V <sub>GS</sub>   | Gate-Source Voltage Continuous                    | ±30         | Volts  |  |
| V <sub>GSM</sub>  | Gate-Source Voltage Transient                     | ±40         |        |  |
| P <sub>D</sub>    | Total Power Dissipation @ T <sub>C</sub> = 25°C   | 540         | Watts  |  |
| , D               | Linear Derating Factor                            | 4.32        | W/°C   |  |
| $T_J$ , $T_{STG}$ | Operating and Storage Junction Temperature Range  | -55 to 150  | -°C    |  |
| TL                | Lead Temperature: 0.063" from Case for 10 Sec.    | 300         | $\neg$ |  |
| I <sub>AR</sub>   | Avalanche Current (Repetitive and Non-Repetitive) | 25          | Amps   |  |
| E <sub>AR</sub>   | Repetitive Avalanche Energy ①                     | 50          |        |  |
| E <sub>AS</sub>   | Single Pulse Avalanche Energy <sup>(4)</sup>      | 3000        | mJ     |  |

#### STATIC ELECTRICAL CHARACTERISTICS

| Symbol              | Characteristic / Test Conditions   | MIN  | TYP | MAX   | UNIT  |
|---------------------|--|------|-----|-------|-------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage $(V_{GS} = 0V, I_D = 250\mu\text{A})$                         | 1000 |     |       | Volts |
| I <sub>D(on)</sub>  | On State Drain Current ② $(V_{DS} > I_{D(on)} \times R_{DS(on)} Max, V_{GS} = 10V)$          | 25   |     |       | Amps  |
| R <sub>DS(on)</sub> | Drain-Source On-State Resistance ② (V <sub>GS</sub> = 10V, 0.5 I <sub>D[Cont.]</sub> )       |      |     | 0.350 | Ohms  |
| I <sub>DSS</sub>    | Zero Gate Voltage Drain Current $(V_{DS} = V_{DSS}, V_{GS} = 0V)$                            |      |     | 25    | μΑ    |
|                     | Zero Gate Voltage Drain Current ( $V_{DS} = 0.8 V_{DSS}$ , $V_{GS} = 0V$ , $T_{C} = 125$ °C) |      |     | 250   |       |
| I <sub>GSS</sub>    | Gate-Source Leakage Current (V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V)                   |      |     | ±100  | nA    |
| V <sub>GS(th)</sub> | Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 2.5 \text{mA})$                            | 3    |     | 5     | Volts |

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

USA 405 S.W. Columbia Street EUROPE Chemin de Magret Bend, Oregon 97702-1035 F-33700 Merignac - France Phone: (541) 382-8028 Phone: (33) 5 57 92 15 15 FAX: (541) 388-0364

FAX: (33) 5 56 47 97 61

| Symbol              | Characteristic               | Test Conditions                      | MIN | TYP  | MAX | UNIT |
|---------------------|------------------------------|--------------------------------------|-----|------|-----|------|
| C <sub>iss</sub>    | Input Capacitance            | V <sub>GS</sub> = 0V                 |     | 5300 |     |      |
| C <sub>oss</sub>    | Output Capacitance           | $V_{DS} = 25V$                       |     | 870  |     | pF   |
| C <sub>rss</sub>    | Reverse Transfer Capacitance | f = 1 MHz                            |     | 174  |     |      |
| $Q_g$               | Total Gate Charge ③          | V <sub>GS</sub> = 10V                |     | 203  |     |      |
| $Q_{gs}$            | Gate-Source Charge           | $V_{DD} = 0.5 V_{DSS}$               |     | 31   |     | nC   |
| $Q_{gd}$            | Gate-Drain ("Miller") Charge | $I_{D} = I_{D[Cont.]} @ 25^{\circ}C$ |     | 135  |     |      |
| t <sub>d(on)</sub>  | Turn-on Delay Time           | V <sub>GS</sub> = 15V                |     | 15   |     |      |
| t <sub>r</sub>      | Rise Time                    | $V_{DD} = 0.5 V_{DSS}$               |     | 6    |     | no   |
| t <sub>d(off)</sub> | Turn-off Delay Time          | $I_{D} = I_{D[Cont.]} @ 25^{\circ}C$ |     | 31   |     | ns   |
| t <sub>f</sub>      | Fall Time                    | $R_G = 0.6\Omega$                    |     | 6    | ·   |      |

#### SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol          | Characteristic / Test Conditions   | MIN | TYP  | MAX | UNIT  |
|-----------------|--|-----|------|-----|-------|
| I <sub>s</sub>  | Continuous Source Current (Body Diode)   |     |      | 25  | Amna  |
| I <sub>SM</sub> | Pulsed Source Current ① (Body Diode)   |     |      | 100 | Amps  |
| V <sub>SD</sub> | Diode Forward Voltage ② (V <sub>GS</sub> = 0V, I <sub>S</sub> = -I <sub>D[Cont.]</sub> ) |     |      | 1.3 | Volts |
| t <sub>rr</sub> | Reverse Recovery Time $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$                      |     | 1060 |     | ns    |
| Q <sub>rr</sub> | Reverse Recovery Charge $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$                    |     | 26.0 |     | μC    |

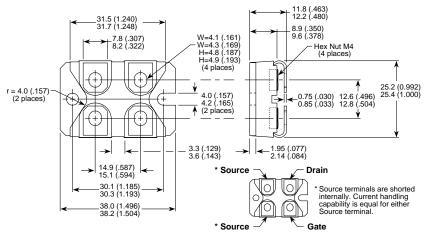
#### THERMAL CHARACTERISTICS

| Symbol         | Characteristic      | MIN | TYP | MAX  | UNIT |
|----------------|---------------------|-----|-----|------|------|
| $R_{	hetaJC}$  | Junction to Case    |     |     | 0.23 | °C/W |
| $R_{\thetaJA}$ | Junction to Ambient |     |     | 40   |      |

① Repetitive Rating: Pulse width limited by maximum junction temperature.

APT Reserves the right to change, without notice, the specifications and information contained herein.

### SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

<sup>3</sup> See MIL-STD-750 Method 3471

 $<sup>\</sup>bigcirc$  Starting T<sub>i</sub> = +25°C, L = 9.6mH, R<sub>G</sub> = 25Ω, Peak I<sub>L</sub> = 25A

② Pulse Test: Pulse width < 380 μS, Duty Cycle < 2%